料

24 24 below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I was an an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF LAMINATING COPPER FOIL ONTO A PRINTED CIRCUIT BOARD

the specification of v	vhich					
I hereby state specification, including	07/03/01 Serial No that I have	e reviewed s, as amen	and und	nd was amended or derstand the conte ny amendment refe n which is material	nts of the aborred to above.	
application in accord	ance with Ti	tle 37, Coo	de of Fede	eral Regulations, §	1.56(a).	
I hereby claim	foreign pric	ority benef	its under	Title 35, Untied S	states Code, §	119 of an
foreign application(s any foreign applicati application on which Prior Foreign Applica	ion for pater priority is cla	nt or inver				
Number	Cour	ntry	Date F	iled(yyyy/mm/dd)	Yes	No
						×
I hereby appoint the following transact all business in the Paten Jiawei Huang Maria Erlinda C. Sarno Belinda Lee					ewith: (Reg. No ong (Reg. No	eation and to b. 39,081) b. 44,011) b. 38,962)
SEND CORRESPONDENCE TO:				DIRECT TELEPHONE CALLS TO: (Name and Telephone Number)		
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hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these has been been that willful false statements and the like so made are statements made on information and belief are believed to be true; and further that these TENT & TRASE tements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any

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